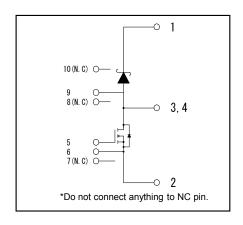
Application

- · Motor drive
- · Converter
- · Photovoltaics, wind power generation.

Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

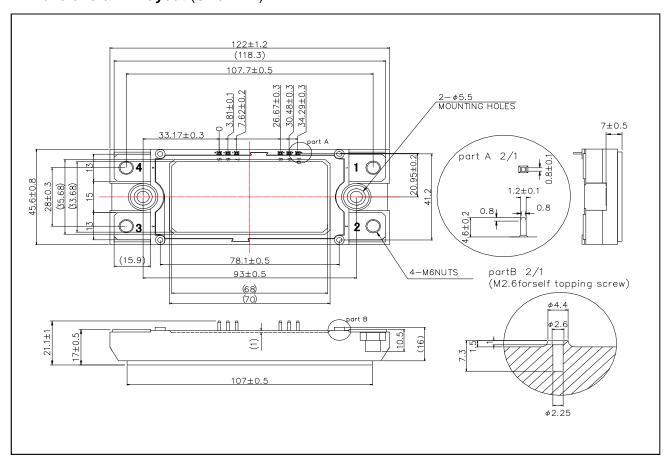
●Circuit diagram



Construction

This product is a chopper module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

●Dimensions & Pin layout (Unit : mm)

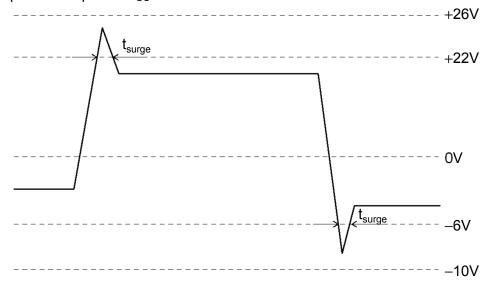


● Absolute maximum ratings (T_j = 25°C)

Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V_{DSS}	G-S short	1200		
Repetitive reverse voltage	V_{DSS}	Clamp diode	1200		
Gate-source voltage(+)	V	D-S short	22	V	
Gate-source voltage(-)	V_{GSS}	D-S SHOIL	– 6	1	
G - S Voltage (t _{surge} <300nsec)	V_{GSS_surge}	D-S short	-10 to 26	1	
Drain current *1	I _D	DC (T _c =60°C)	134		
	I _{DRM}	Pulse (T _c =60°C) 1ms *2	240	1	
	I _{DRM}	Pulse (T _c =60°C) 10us *2	360		
Source current *1	I _S	DC (T _c =60°C) V _{GS} =18V	134		
	I _{SRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240	Α	
	I _{SRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360	1	
Forward curent (clamp diode) *1	I _F	DC (T _c =60°C) V _{GS} =18V	134	1	
	I _{FRM}	Pulse (Tc=60°C) 1ms V _{GS} =18V * ²	240	1	
	I _{FRM}	Pulse (Tc=60°C) 10us V _{GS} =18V * ²	360		
Total power disspation *4	Ptot	T _c =25°C	935	W	
Max Junction Temperature	T _{jmax}		175		
Junction temperature	T_jop		-40 to150	°C	
Storage temperature	T _{stg}		-40 to125	1	
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min. 2500		Vrms	
Mounting torque		Main Terminals : M6 screw	4.5	N · m	
	_	Mounting to heat shink: M5 screw	3.5	14 . 111	

^(*1) Case temperature (T_c) is defined on the surface of base plate just under the chips.

Example of acceptable V_{GS} waveform



^(*2) Repetition rate should be kept within the range where temperature rise if die should not exceed $T_{j \text{ max.}}$

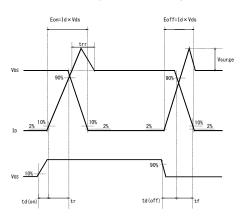
^(*3) T_j is less than 175°C

●Electrical characteristics (T_i=25°C)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
On-state static Drain-Source Voltage	$V_{DS(on)}$	I _D 120A, V _{GS} =18V	T _j =25°C	1	2.1	3.2	V
			T _j =125°C	ı	3.1	-	
			T _j =150°C	-	3.4	5.2	
Drain cutoff current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V		ı	-	10	μΑ
Forwad Voltage	V _F	I _F =120A	T _j =25°C	1	1.7	2.1	٧
			T _j =125°C		2.2	-	
			T _j =150°C	-	2.4	3.2	
Reverse curent	I _{RRM}	Clamp diode		-	-	2	mA
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} =10V, I_{D} =22mA	V_{DS} =10V, I_{D} =22mA		-	4	V
Gate-source leakage current	_	V _{GS} =22V, V _{DS} =0V		-	-	0.5	μΑ
	I _{GSS}	V_{GS} = -6V, V_{DS} =0V		-0.5	-	-	
Switching characteristics	t _{d(on)}	V _{GS(on)} =18V, V _{GS(off)} =0V		-	30	-	ns
	t _r	V _{DS} =600V		-	40	-	
	t _{rr}	I _D =120A	-	20	-		
	t _{d(off)}	R_G =2.2 Ω inductive load		-	165	_	
	t _f			-	45	-	
Input capacitance	Ciss	V_{DS} =10V, V_{GS} =0V, 1MHz		-	14	-	nF
Gate Registance	R _{Gint}	T _j =25°C		-	1.8	-	Ω
Stray Inductance	Ls				25	-	nH
Creepage Distance	-	Terminal to heat sink			12.5	-	mm
		Terminal to terminal			20	-	mm
Clearance Distance	1	Terminal to heat sink			10.5	-	mm
		Terminal to terminal			14	-	mm
Junction-to-case thermal resistance	R _{th} (j-c)	DMOS (1/2 module) *5		-	-	0.16	°C/W
		SBD (1/2 module) *5		-	-	0.21	
Case-to-heat sink Thermal resistance	R _{th} (c-f)	Case to heat sink, per	1 module,	module,			
		Thermal grease appie	d * ⁶		0.035		

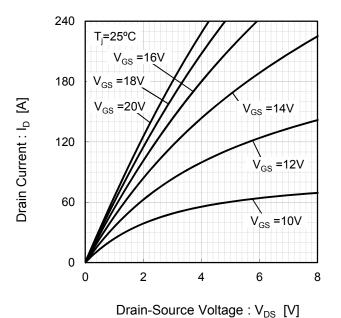
- (*4) In order to prevent self turn-on, it is recommended to apply negative gate bias.
- (*5) Measurement of Tc is to be done at the point just under the chip.
- (*6) Typical value is measured by using thermally conductive grease of λ=0.9W/(m K).
- (*7) SiC devices have lower short cuicuit withstand capability due to high current density. Please be advised to pay careful attention to short cuicuit accident and try to adjust protection time to shutdown them as short as possible.
- (*8) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

<Wavelength for Switching Test>



• Electrical characteristic curves (Typical)

Fig.1 Typical Output Characteristics [T_i =25°C] Fig.2 Drain-Source Voltage vs. Drain Current



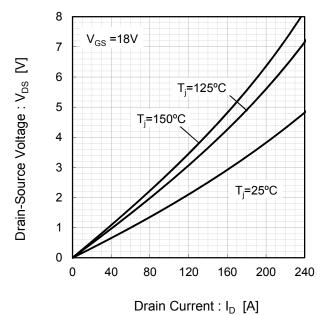
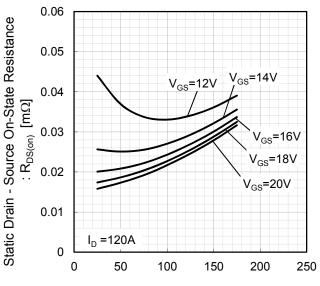


Fig.3 Drain-Source Voltage vs. Gate-Source Voltage [T_i=25°C] 6 T_i=25°C 5 Drain-Source Voltage: V_{DS} [V] 4 3 I_D=120A I_D=100A 2 $I_D = 60A$ 1 I_D=20A 0 12 14 16 18 20 22 24 Gate-Source Voltage : V_{GS} [V]

Fig.4 Static Drain - Source On-State Resistance vs. Junction Temperature



Junction Temperature : T_i [°C]

• Electrical characteristic curves (Typical)

Fig.5 Forward characteristic of Diode

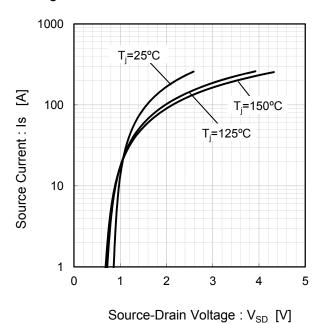
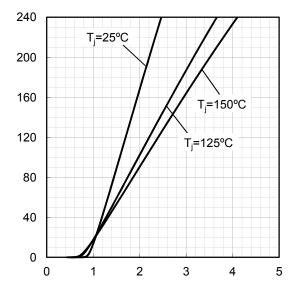


Fig.6 Forward characteristic of Diode



Source-Drain Voltage : V_{SD} [V]

Fig.7 Drain Current vs. Gate-Source Voltage

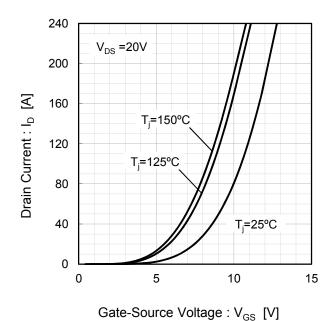
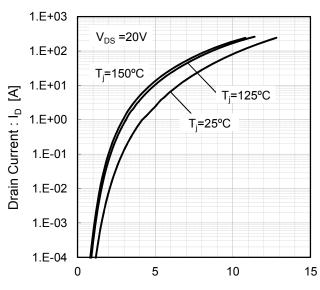


Fig.8 Drain Current vs. Gate-Source Voltage



Gate-Source Voltage : V_{GS} [V]

Source Current: Is [A]

● Electrical characteristic curves (Typical)

Fig.9 Switching Characteristics [T_i=25°C]

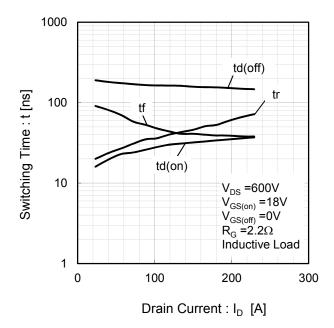


Fig.10 Switching Characteristics [T_i=125°C]

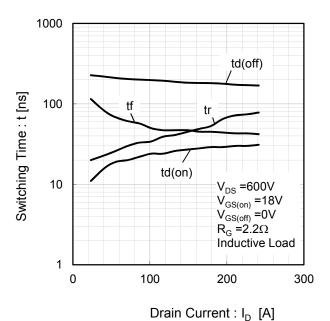


Fig.11 Switching Characteristics [T_i=150°C]

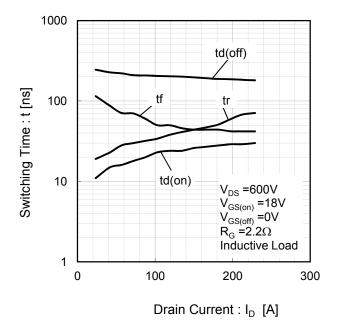
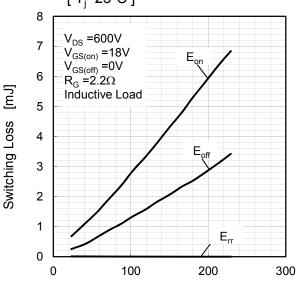


Fig.12 Switching Loss vs. Drain Current [T_i=25°C]



Drain Current : I_D [A]

ROHM

• Electrical characteristic curves (Typical)

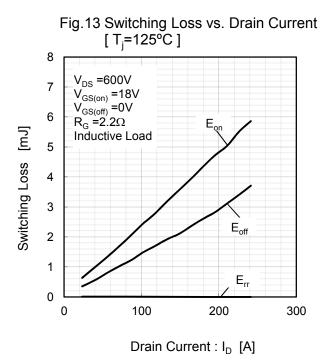


Fig.14 Switching Loss vs. Drain Current $[T_i=150^{\circ}C]$ 8 V_{DS} =600V 7 $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ $R_G = 2.2\Omega$ 6 Inductive Load 5 4 3 $\mathsf{E}_{\mathsf{off}}$ 2 1 E_{rr} 0 100 200 300

Drain Current : I_D [A]

Fig.15 Recovery Characteristics vs. Fig.16 Recovery Characteristics vs. Drain Current [T_i=25°C] Drain Current [T_i=125°C] 100 10 100 100 Irr Recovery Current : I_{rr} [A] Recovery Current : In [A] Recovery Time : t_{rr} [ns] Recovery Time: t_{rr} [ns] trr trr Irr 10 10 V_{DS} =600V V_{DS} =600V $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ $R_G = 2.2\Omega$ $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ $R_G = 2.2\Omega$ Inductive Load Inductive Load 1 0.1 100 0 100 200 300 0 200 300 Drain Current : I_D [A] Drain Current : I_D [A]

<u>"</u>

Switching Loss

●Electrical characteristic curves (Typical)

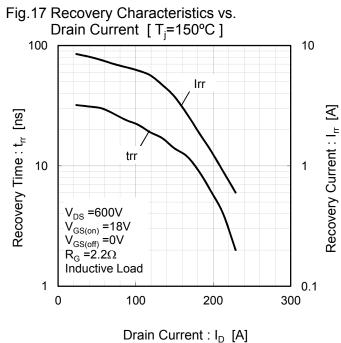


Fig. 18 Switching Characteristics vs. Gate Resistance $[T_j=25^{\circ}C]$ 10000 $V_{DS} = 600V$ $V_{DS} = 18V$ $V_{CS(on)} = 18V$ $V_{CS(off)} = 0V$ Inductive Load

1000

101

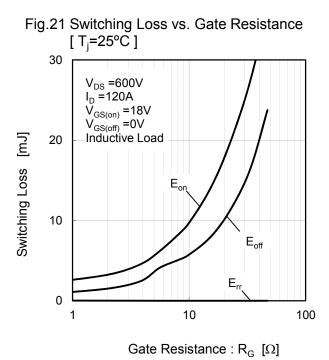
100

100

Gate Resistance : R_G [Ω]

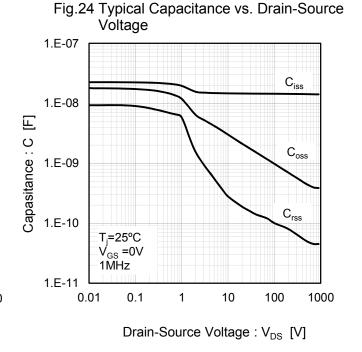
Fig. 20 Switching Characteristics vs. Gate Resistance [T_j =150°C] $V_{DS} = 600V$ $V_{DS} = 120A$ $V_{GS(off)} = 10V$ Inductive Load $V_{GS(off)} = 0V$ $V_{GS(o$

● Electrical characteristic curves (Typical)



Gate Resistance : R_G [Ω]

Fig. 23 Switching Loss vs. Gate Resistance $[T_j=150^{\circ}C]$ $V_{DS}=600V$ $I_{D}=120A$ $V_{GS(on)}=18V$ $V_{GS(off)}=0V$ Inductive Load $V_{GS(off)}=0V$ $V_$



Switching Loss [mJ]

● Electrical characteristic curves (Typical)

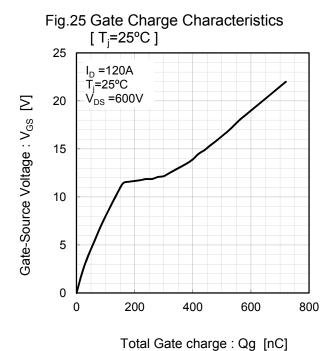


Fig.26 Normalized Transient Thermal Impedance Normalized Transient Thermal Impedance: Rth 0.1 Single Pulse T_c=25°C Per unit base DMOS part : 0.16K/W SBD part : 0.21K/W 0.01 0.0001 0.001 0.1 10 0.01 1 Time [s]

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Package	С
Unit Quantity	12
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Packing Type	Corrugated Cardboard
Constitution Materials List	inquiry
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